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		GARROU, Wafer-Level Packaging Has Arrived, Semiconductor International, Oct. 2000, 119 et seq					
	YOUNG, Wafer-level Processing, May 1997, Chip Scale Revie May 1997, 28 et seq.						
		NGUYEN et al., Assembly Considerations for SMD Wafer-Level CSPs, Chip Scale Review, May/June 2000, 48 et seq.					
		CHAN et al., Integrated Antennas on Si,, IEDM 10-903, 0-7803-7050-3/01/\$10.00 copr. 2001 IEEE, 40.6.1 et seq.					
PENNWELL CORP., Is THIS the industry's next killer application of the complete of the period of the period of the complete of the period of th							
		LIHUI et al., High Q Multilayer Spiral Inductor on Silicon Chip for 5-6 GHz, IEEE Electron Device Letters, Vol. 23, No. 8, August 2002, 470 et seq.					

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